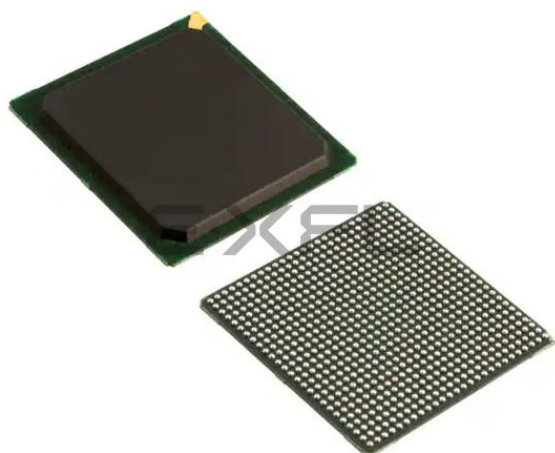




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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

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Details

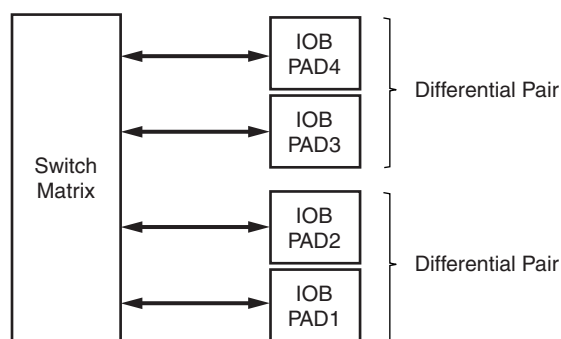
Product Status	Obsolete
Number of LABs/CLBs	3584
Number of Logic Elements/Cells	-
Total RAM Bits	1769472
Number of I/O	484
Number of Gates	3000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v3000-4fgg676c

Detailed Description

Input/Output Blocks (IOBs)

Virtex-II™ I/O blocks (IOBs) are provided in groups of two or four on the perimeter of each device. Each IOB can be used as input and/or output for single-ended I/Os. Two IOBs can be used as a differential pair. A differential pair is always connected to the same switch matrix, as shown in **Figure 1**.

IOB blocks are designed for high performances I/Os, supporting 19 single-ended standards, as well as differential signaling with LVDS, LDT, Bus LVDS, and LVPECL.



DS031_30_101600

Figure 1: Virtex-II Input/Output Tile

Note: Differential I/Os must use the same clock.

Supported I/O Standards

Virtex-II IOB blocks feature SelectI/O-Ultra inputs and outputs that support a wide variety of I/O signaling standards. In addition to the internal supply voltage ($V_{CCINT} = 1.5V$), output driver supply voltage (V_{CCO}) is dependent on the I/O standard (see **Table 1** and **Table 2**). An auxiliary supply voltage ($V_{CCAUX} = 3.3V$) is required, regardless of the I/O standard used. For exact supply voltage absolute maximum ratings, see **DC Input and Output Levels** in Module 3.

All of the user IOBs have fixed-clamp diodes to V_{CCO} and to ground. As outputs, these IOBs are not compatible or compliant with 5V I/O standards. As inputs, these IOBs are not normally 5V tolerant, but can be used with 5V I/O standards when external current-limiting resistors are used. For more details, see the “5V Tolerant I/Os” Tech Topic at www.xilinx.com.

Table 3 lists supported I/O standards with Digitally Controlled Impedance. See **Digitally Controlled Impedance (DCI)**, page 8.

Table 1: Supported Single-Ended I/O Standards

IOSTANDARD Attribute	Output V_{CCO}	Input V_{CCO}	Input V_{REF}	Board Termination Voltage (V_{TT})
LVTTTL	3.3	3.3	N/R ⁽³⁾	N/R
LVC MOS33	3.3	3.3	N/R	N/R
LVC MOS25	2.5	2.5	N/R	N/R
LVC MOS18	1.8	1.8	N/R	N/R
LVC MOS15	1.5	1.5	N/R	N/R
PCI33_3	3.3	3.3	N/R	N/R
PCI66_3	3.3	3.3	N/R	N/R
PCI-X	3.3	3.3	N/R	N/R
GTL	Note (1)	Note (1)	0.8	1.2
GTLP	Note (1)	Note (1)	1.0	1.5
HSTL_I	1.5	N/R	0.75	0.75
HSTL_II	1.5	N/R	0.75	0.75
HSTL_III	1.5	N/R	0.9	1.5
HSTL_IV	1.5	N/R	0.9	1.5
HSTL_I_18	1.8	N/R	0.9	0.9
HSTL_II_18	1.8	N/R	0.9	0.9
HSTL_III_18	1.8	N/R	1.1	1.8
HSTL_IV_18	1.8	N/R	1.1	1.8
SSTL18_I ⁽²⁾	1.8	N/R	0.9	0.9
SSTL18_II	1.8	N/R	0.9	0.9
SSTL2_I	2.5	N/R	1.25	1.25
SSTL2_II	2.5	N/R	1.25	1.25
SSTL3_I	3.3	N/R	1.5	1.5
SSTL3_II	3.3	N/R	1.5	1.5
AGP-2X/AGP	3.3	N/R	1.32	N/R

Notes:

- V_{CCO} of GTL or GTLP should not be lower than the termination voltage or the voltage seen at the I/O pad. Example: If the pin High level is 1.5V, connect V_{CCO} to 1.5V.
- SSTL18_I is not a JEDEC-supported standard.
- N/R = no requirement.

Table 8: SelectI/O-Ultra Differential Buffers With On-Chip Termination

I/O Standard Description	IOSTANDARD Attribute	
	External Termination	On-Chip Termination
LVDS 2.5V	LVDS_25	LVDS_25_DCI
LVDS Extended 2.5V	LVDSEXT_25	LVDSEXT_25_DCI

Figure 11 provides examples illustrating the use of the HSTL_I_DCI, HSTL_II_DCI, HSTL_III_DCI, and HSTL_IV_DCI I/O standards. For a complete list, see the [Virtex-II Platform FPGA User Guide](#).

	HSTL_I	HSTL_II	HSTL_III	HSTL_IV
Conventional				
DCI Transmit Conventional Receive				
Conventional Transmit DCI Receive				
DCI Transmit DCI Receive				
Bidirectional	N/A		N/A	
Reference Resistor	$VRN = VRP = R = Z_0$	$VRN = VRP = R = Z_0$	$VRN = VRP = R = Z_0$	$VRN = VRP = R = Z_0$
Recommended $Z_0^{(1)}$	50 Ω	50 Ω	50 Ω	50 Ω

Note:

1. Z_0 is the recommended PCB trace impedance.

DS031_65a_100201

Figure 11: HSTL DCI Usage Examples

Configurable Logic Blocks (CLBs)

The Virtex-II configurable logic blocks (CLB) are organized in an array and are used to build combinatorial and synchronous logic designs. Each CLB element is tied to a switch matrix to access the general routing matrix, as shown in Figure 14. A CLB element comprises 4 similar slices, with fast local feedback within the CLB. The four slices are split in two columns of two slices with two independent carry logic chains and one common shift chain.

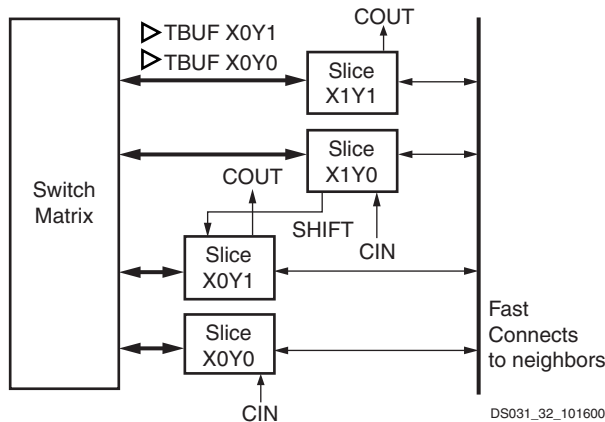


Figure 14: Virtex-II CLB Element

Slice Description

Each slice includes two 4-input function generators, carry logic, arithmetic logic gates, wide function multiplexers and two storage elements. As shown in Figure 15, each 4-input function generator is programmable as a 4-input LUT, 16 bits of distributed SelectRAM memory, or a 16-bit variable-tap shift register element.

The output from the function generator in each slice drives both the slice output and the D input of the storage element. Figure 16 shows a more detailed view of a single slice.

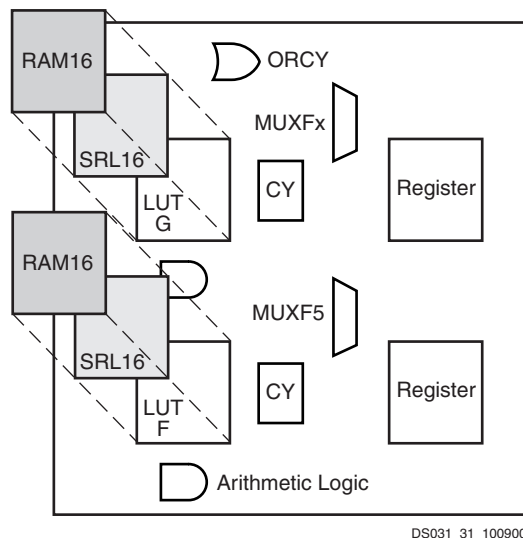


Figure 15: Virtex-II Slice Configuration

Configurations

Look-Up Table

Virtex-II function generators are implemented as 4-input look-up tables (LUTs). Four independent inputs are provided to each of the two function generators in a slice (F and G). These function generators are each capable of implementing any arbitrarily defined boolean function of four inputs. The propagation delay is therefore independent of the function implemented. Signals from the function generators can exit the slice (X or Y output), can input the XOR dedicated gate (see arithmetic logic), or input the carry-logic multiplexer (see fast look-ahead carry logic), or feed the D input of the storage element, or go to the MUXF5 (not shown in Figure 16).

In addition to the basic LUTs, the Virtex-II slice contains logic (MUXF5 and MUXFX multiplexers) that combines function generators to provide any function of five, six, seven, or eight inputs. The MUXFX are either MUXF6, MUXF7 or MUXF8 according to the slice considered in the CLB. Selected functions up to nine inputs (MUXF5 multiplexer) can be implemented in one slice. The MUXFX can also be a MUXF6, MUXF7, or MUXF8 multiplexers to map any functions of six, seven, or eight inputs and selected wide logic functions.

Register/Latch

The storage elements in a Virtex-II slice can be configured either as edge-triggered D-type flip-flops or as level-sensitive latches. The D input can be directly driven by the X or Y output via the DX or DY input, or by the slice inputs bypassing the function generators via the BX or BY input. The clock enable signal (CE) is active High by default. If left unconnected, the clock enable for that storage element defaults to the active state.

In addition to clock (CK) and clock enable (CE) signals, each slice has set and reset signals (SR and BY slice inputs). SR forces the storage element into the state specified by the attribute SRHIGH or SRLOW. SRHIGH forces a logic "1" when SR is asserted. SRLOW forces a logic "0". When SR is used, a second input (BY) forces the storage element into the opposite state. The reset condition is predominant over the set condition. (See Figure 17.)

The initial state after configuration or global initial state is defined by a separate INIT0 and INIT1 attribute. By default, setting the SRLOW attribute sets INIT0, and setting the SRHIGH attribute sets INIT1. For each slice, set and reset can be set to be synchronous or asynchronous. Virtex-II devices also have the ability to set INIT0 and INIT1 independent of SRHIGH and SRLOW.

The control signals clock (CLK), clock enable (CE) and set/reset (SR) are common to both storage elements in one slice. All of the control signals have independent polarity. Any inverter placed on a control input is automatically absorbed.

Table 17: IOB Output Switching Characteristics Standard Adjustments (Continued)

Description	IOSTANDARD Attribute	Timing Parameter	Speed Grade			Units
			-6	-5	-4	
LVC MOS, 2.5V, Fast, 16 mA	LVC MOS25_F16	T _{OLVCMOS25_F16}	−0.18	−0.19	−0.21	ns
LVC MOS, 2.5V, Fast, 24 mA	LVC MOS25_F24	T _{OLVCMOS25_F24}	−0.35	−0.36	−0.40	ns
LVC MOS, 1.8V, Slow, 2 mA	LVC MOS18_S2	T _{OLVCMOS18_S2}	15.62	16.10	17.71	ns
LVC MOS, 1.8V, Slow, 4 mA	LVC MOS18_S4	T _{OLVCMOS18_S4}	10.20	10.51	11.57	ns
LVC MOS, 1.8V, Slow, 6 mA	LVC MOS18_S6	T _{OLVCMOS18_S6}	7.52	7.75	8.53	ns
LVC MOS, 1.8V, Slow, 8 mA	LVC MOS18_S8	T _{OLVCMOS18_S8}	6.87	7.08	7.78	ns
LVC MOS, 1.8V, Slow, 12 mA	LVC MOS18_S12	T _{OLVCMOS18_S12}	5.54	5.71	6.28	ns
LVC MOS, 1.8V, Slow, 16 mA	LVC MOS18_S16	T _{OLVCMOS18_S16}	5.31	5.47	6.02	ns
LVC MOS, 1.8V, Fast, 2 mA	LVC MOS18_F2	T _{OLVCMOS18_F2}	5.55	5.72	6.30	ns
LVC MOS, 1.8V, Fast, 4 mA	LVC MOS18_F4	T _{OLVCMOS18_F4}	1.89	1.95	2.15	ns
LVC MOS, 1.8V, Fast, 6 mA	LVC MOS18_F6	T _{OLVCMOS18_F6}	0.83	0.85	0.94	ns
LVC MOS, 1.8V, Fast, 8 mA	LVC MOS18_F8	T _{OLVCMOS18_F8}	0.70	0.72	0.80	ns
LVC MOS, 1.8V, Fast, 12 mA	LVC MOS18_F12	T _{OLVCMOS18_F12}	0.26	0.27	0.30	ns
LVC MOS, 1.8V, Fast, 16 mA	LVC MOS18_F16	T _{OLVCMOS18_F16}	0.23	0.23	0.26	ns
LVC MOS, 1.5V, Slow, 2 mA	LVC MOS15_S2	T _{OLVCMOS15_S2}	18.96	19.55	21.50	ns
LVC MOS, 1.5V, Slow, 4 mA	LVC MOS15_S4	T _{OLVCMOS15_S4}	12.77	13.17	14.48	ns
LVC MOS, 1.5V, Slow, 6 mA	LVC MOS15_S6	T _{OLVCMOS15_S6}	12.05	12.42	13.66	ns
LVC MOS, 1.5V, Slow, 8 mA	LVC MOS15_S8	T _{OLVCMOS15_S8}	9.75	10.06	11.06	ns
LVC MOS, 1.5V, Slow, 12 mA	LVC MOS15_S12	T _{OLVCMOS15_S12}	9.04	9.32	10.25	ns
LVC MOS, 1.5V, Slow, 16 mA	LVC MOS15_S16	T _{OLVCMOS15_S16}	8.21	8.46	9.31	ns
LVC MOS, 1.5V, Fast, 2 mA	LVC MOS15_F2	T _{OLVCMOS15_F2}	5.09	5.25	5.78	ns
LVC MOS, 1.5V, Fast, 4 mA	LVC MOS15_F4	T _{OLVCMOS15_F4}	2.01	2.07	2.27	ns
LVC MOS, 1.5V, Fast, 6 mA	LVC MOS15_F6	T _{OLVCMOS15_F6}	1.46	1.51	1.66	ns
LVC MOS, 1.5V, Fast, 8 mA	LVC MOS15_F8	T _{OLVCMOS15_F8}	0.93	0.96	1.05	ns
LVC MOS, 1.5V, Fast, 12 mA	LVC MOS15_F12	T _{OLVCMOS15_F12}	0.74	0.77	0.84	ns
LVC MOS, 1.5V, Fast, 16 mA	LVC MOS15_F16	T _{OLVCMOS15_F16}	0.67	0.69	0.75	ns
LVDS (Low-Voltage Differential Signaling), 2.5V	LVDS_25	T _{OLVDS_25}	−0.31	−0.32	−0.36	ns
LVDS, 3.3V	LVDS_33	T _{OLVDS_33}	−0.25	−0.26	−0.29	ns
LVDSEXT (LVDS Extended Mode), 2.5V	LVDSEXT_25	T _{OLVDSEXT_25}	−0.18	−0.19	−0.21	ns
LVDSEXT, 3.3V	LVDSEXT_33	T _{OLVDSEXT_33}	−0.17	−0.18	−0.19	ns
ULVDS (Ultra LVDS), 2.5V	ULVDS_25	T _{OLVDS_25}	−0.20	−0.21	−0.23	ns
BLVDS (Bus LVDS), 2.5V	BLVDS_25	T _{OBLVDS_25}	0.67	0.69	0.76	ns
LDT (HyperTransport), 2.5V	LDT_25	T _{OLDT_25}	−0.20	−0.21	−0.23	ns
LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V	LVPECL_33	T _{OLVPECL_33}	0.29	0.30	0.33	ns
PCI (Peripheral Component Interface), 33 MHz, 3.3V	PCI33_3	T _{OPCI33_3}	1.15	1.19	1.31	ns
PCI, 66 MHz, 3.3V	PCI66_3	T _{OPCI66_3}	−0.01	−0.01	−0.01	ns
PCI-X, 133 MHz, 3.3V	PCIX	T _{OPCIX}	−0.01	−0.01	−0.01	ns
GTL (Gunning Transceiver Logic)	GTL	T _{OGTL}	−0.31	−0.32	−0.36	ns
GTL Plus	GTL P	T _{OGTLP}	−0.17	−0.18	−0.20	ns
HSTL (High-Speed Transceiver Logic), Class I	HSTL_I	T _{OHSTL_I}	0.26	0.27	0.29	ns
HSTL, Class II	HSTL_II	T _{OHSTL_II}	−0.15	−0.16	−0.17	ns
HSTL, Class III	HSTL_III	T _{OHSTL_III}	−0.17	−0.17	−0.19	ns
HSTL, Class IV	HSTL_IV	T _{OHSTL_IV}	−0.40	−0.41	−0.45	ns
HSTL, Class I, 1.8V	HSTL_I_18	T _{OHSTL_I_18}	0.03	0.03	0.04	ns

Table 27: Enhanced Pipelined Multiplier Switching Characteristics

Description	Symbol	Speed Grade			Units
		-6	-5	-4	
Setup and Hold Times Before/After Clock					
Data Inputs	T _{MULIDCK} /T _{MULCKID}	3.00/0.00	3.45/0.00	3.89/0.00	ns, Max
Clock Enable	T _{MULIDCK_CE} /T _{MULCKID_CE}	0.72/0.00	0.80/0.00	0.86/0.00	ns, Max
Reset	T _{MULIDCK_RST} /T _{MULCKID_RST}	0.72/0.00	0.80/0.00	0.86/0.00	ns, Max
Clock to Output Pin					
Clock to Pin 35	T _{MULTCK1_P35}	3.05	3.25	3.74	ns, Max
Clock to Pin 34	T _{MULTCK1_P34}	2.95	3.14	3.61	ns, Max
Clock to Pin 33	T _{MULTCK1_P33}	2.85	3.04	3.49	ns, Max
Clock to Pin 32	T _{MULTCK1_P32}	2.76	2.93	3.37	ns, Max
Clock to Pin 31	T _{MULTCK1_P31}	2.66	2.82	3.25	ns, Max
Clock to Pin 30	T _{MULTCK1_P30}	2.56	2.72	3.12	ns, Max
Clock to Pin 29	T _{MULTCK1_P29}	2.47	2.61	3.00	ns, Max
Clock to Pin 28	T _{MULTCK1_P28}	2.37	2.50	2.88	ns, Max
Clock to Pin 27	T _{MULTCK1_P27}	2.27	2.40	2.75	ns, Max
Clock to Pin 26	T _{MULTCK1_P26}	2.17	2.29	2.63	ns, Max
Clock to Pin 25	T _{MULTCK1_P25}	2.08	2.18	2.51	ns, Max
Clock to Pin 24	T _{MULTCK1_P24}	1.98	2.07	2.38	ns, Max
Clock to Pin 23	T _{MULTCK1_P23}	1.88	1.97	2.26	ns, Max
Clock to Pin 22	T _{MULTCK1_P22}	1.79	1.86	2.14	ns, Max
Clock to Pin 21	T _{MULTCK1_P21}	1.69	1.75	2.02	ns, Max
Clock to Pin 20	T _{MULTCK1_P20}	1.59	1.65	1.89	ns, Max
Clock to Pin 19	T _{MULTCK1_P19}	1.50	1.54	1.77	ns, Max
Clock to Pin 18	T _{MULTCK1_P18}	1.40	1.43	1.65	ns, Max
Clock to Pin 17	T _{MULTCK1_P17}	1.30	1.33	1.52	ns, Max
Clock to Pin 16	T _{MULTCK1_P16}	1.20	1.22	1.40	ns, Max
Clock to Pin 15	T _{MULTCK1_P15}	1.11	1.11	1.28	ns, Max
Clock to Pin 14	T _{MULTCK1_P14}	1.01	1.00	1.15	ns, Max
Clock to Pin 13	T _{MULTCK1_P13}	0.91	1.00	1.15	ns, Max
Clock to Pin 12	T _{MULTCK1_P12}	0.91	1.00	1.15	ns, Max
Clock to Pin 11	T _{MULTCK1_P11}	0.91	1.00	1.15	ns, Max
Clock to Pin 10	T _{MULTCK1_P10}	0.91	1.00	1.15	ns, Max
Clock to Pin 9	T _{MULTCK1_P9}	0.91	1.00	1.15	ns, Max
Clock to Pin 8	T _{MULTCK1_P8}	0.91	1.00	1.15	ns, Max
Clock to Pin 7	T _{MULTCK1_P7}	0.91	1.00	1.15	ns, Max
Clock to Pin 6	T _{MULTCK1_P6}	0.91	1.00	1.15	ns, Max
Clock to Pin 5	T _{MULTCK1_P5}	0.91	1.00	1.15	ns, Max
Clock to Pin 4	T _{MULTCK1_P4}	0.91	1.00	1.15	ns, Max
Clock to Pin 3	T _{MULTCK1_P3}	0.91	1.00	1.15	ns, Max
Clock to Pin 2	T _{MULTCK1_P2}	0.91	1.00	1.15	ns, Max
Clock to Pin 1	T _{MULTCK1_P1}	0.91	1.00	1.15	ns, Max
Clock to Pin 0	T _{MULTCK1_P0}	0.91	1.00	1.15	ns, Max

Table 47: Sample Window

Description	Symbol	Device	Speed Grade			Units
			-6	-5	-4	
Sampling Error at Receiver Pins ⁽¹⁾	T _{SAMP}	XC2V40	500	500	550	ps
		XC2V80	500	500	550	ps
		XC2V250	500	500	550	ps
		XC2V500	500	500	550	ps
		XC2V1000	500	500	550	ps
		XC2V1500	500	500	550	ps
		XC2V2000	500	500	550	ps
		XC2V3000	500	500	550	ps
		XC2V4000	500	500	550	ps
		XC2V6000	500	500	550	ps
		XC2V8000		500	550	ps

Notes:

- This parameter indicates the total sampling error of Virtex-II DDR input registers across voltage, temperature, and process. The characterization methodology uses the DCM to capture the DDR input registers' edges of operation. These measurements include:
 - CLK0 and CLK180 DCM jitter
 - Worst-case Duty-Cycle Distortion - T_{DCD_CLK180}
 - DCM accuracy (phase offset)
 - DCM phase shift resolution.
These measurements do not include package or clock tree skew.

Table 48: Pin-to-Pin Setup/Hold: Source-Synchronous Configuration

Description	Symbol	Device	Speed Grade			Units
			-6	-5	-4	
Data Input Set-Up and Hold Times Relative to a Forwarded Clock Input Pin, Using DCM and Global Clock Buffer. For situations where clock and data inputs conform to different standards, adjust the setup and hold values accordingly using the values shown in IOB Input Switching Characteristics Standard Adjustments , page 11.						
No Delay Global Clock and IFF with DCM	T _{PSDCM} / T _{PHDCM}	XC2V40	0.2/0.5	0.2/0.5	0.2/0.5	ns
		XC2V80	0.2/0.5	0.2/0.5	0.2/0.5	ns
		XC2V250	0.2/0.5	0.2/0.5	0.2/0.5	ns
		XC2V500	0.2/0.5	0.2/0.5	0.2/0.5	ns
		XC2V1000	0.2/0.5	0.2/0.5	0.2/0.5	ns
		XC2V1500	0.2/0.5	0.2/0.5	0.2/0.5	ns
		XC2V2000	0.2/0.5	0.2/0.5	0.2/0.5	ns
		XC2V3000	0.2/0.5	0.2/0.5	0.2/0.6	ns
		XC2V4000	0.2/0.5	0.2/0.6	0.2/0.6	ns
		XC2V6000	0.2/0.5	0.2/0.6	0.2/0.6	ns
		XC2V8000		0.2/0.6	0.2/0.7	ns

Notes:

- IFF = Input Flip-Flop
- The timing values were measured using the fine-phase adjustment feature of the DCM.
- The worst-case duty-cycle distortion and DCM jitter on CLK0 and CLK180 is included in these measurements.

Table 5: CS144/CSG144 — XC2V40, XC2V80, and XC2V250

Bank	Pin Description	Pin Number	No Connect in the XC2V40
2	IO_L96N_2	G11	
2	IO_L96P_2	G13	
3	IO_L96N_3	G12	
3	IO_L96P_3	H12	
3	IO_L94N_3	H11	
3	IO_L94P_3	J13	
3	IO_L03N_3/VREF_3	J10	
3	IO_L03P_3	K13	
3	IO_L02N_3/VRP_3	K12	
3	IO_L02P_3/VRN_3	K11	
3	IO_L01N_3	K10	
3	IO_L01P_3	L13	
4	IO_L01N_4/BUSY/DOUT ⁽¹⁾	M11	
4	IO_L01P_4/INIT_B	N11	
4	IO_L02N_4/D0/DIN ⁽¹⁾	L10	
4	IO_L02P_4/D1	M10	
4	IO_L03N_4/D2/ALT_VRP_4	N10	
4	IO_L03P_4/D3/ALT_VRN_4	K9	
4	IO_L94N_4/VREF_4	N9	
4	IO_L94P_4	K8	
4	IO_L95N_4/GCLK3S	L8	
4	IO_L95P_4/GCLK2P	M8	
4	IO_L96N_4/GCLK1S	N8	
4	IO_L96P_4/GCLK0P	K7	
5	IO_L96N_5/GCLK7S	N7	
5	IO_L96P_5/GCLK6P	M7	
5	IO_L95N_5/GCLK5S	N6	
5	IO_L95P_5/GCLK4P	M6	
5	IO_L94N_5	L6	
5	IO_L94P_5/VREF_5	K6	
5	IO_L03N_5/D4/ALT_VRP_5	L5	
5	IO_L03P_5/D5/ALT_VRN_5	K5	
5	IO_L02N_5/D6	N4	
5	IO_L02P_5/D7	M4	
5	IO_L01N_5/RDWR_B	L4	
5	IO_L01P_5/CS_B	K4	

FG676/FGG676 Fine-Pitch BGA Package

As shown in Table 8, XC2V1500, XC2V2000, and XC2V3000 Virtex-II devices are available in the FG676/FGG676 fine-pitch BGA package. Pins in the XC2V1500, XC2V2000, and XC2V3000 devices are the same, except for the pin differences in the XC2V1500 and XC2V2000 devices shown in the No Connect columns. Following this table are the **FG676/FGG676 Fine-Pitch BGA Package Specifications (1.00mm pitch)**.

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
0	IO_L01N_0	D6		
0	IO_L01P_0	C6		
0	IO_L02N_0	B1		
0	IO_L02P_0	A2		
0	IO_L03N_0/VRP_0	D7		
0	IO_L03P_0/VRN_0	C7		
0	IO_L04N_0/VREF_0	B3		
0	IO_L04P_0	A3		
0	IO_L05N_0	G6		
0	IO_L05P_0	G7		
0	IO_L06N_0	E6		
0	IO_L06P_0	E7		
0	IO_L19N_0	B4		
0	IO_L19P_0	A4		
0	IO_L21N_0	B5		
0	IO_L21P_0/VREF_0	A5		
0	IO_L22N_0	B6		
0	IO_L22P_0	A6		
0	IO_L24N_0	A7		
0	IO_L24P_0	A8		
0	IO_L25N_0	E8	NC	NC
0	IO_L25P_0	D8	NC	NC
0	IO_L27N_0	G8	NC	NC
0	IO_L27P_0/VREF_0	F8	NC	NC
0	IO_L49N_0	C8		
0	IO_L49P_0	B8		
0	IO_L51N_0	D9		
0	IO_L51P_0/VREF_0	E9		
0	IO_L52N_0	F9		
0	IO_L52P_0	G9		
0	IO_L54N_0	B9		
0	IO_L54P_0	A9		
0	IO_L67N_0	C9		

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
NA	VCCAUX	P26
NA	VCCAUX	P2
NA	VCCAUX	C26
NA	VCCAUX	C2
NA	VCCAUX	B14
NA	VCCINT	V18
NA	VCCINT	V14
NA	VCCINT	V10
NA	VCCINT	U17
NA	VCCINT	U16
NA	VCCINT	U15
NA	VCCINT	U14
NA	VCCINT	U13
NA	VCCINT	U12
NA	VCCINT	U11
NA	VCCINT	T17
NA	VCCINT	T11
NA	VCCINT	R17
NA	VCCINT	R11
NA	VCCINT	P18
NA	VCCINT	P17
NA	VCCINT	P11
NA	VCCINT	P10
NA	VCCINT	N17
NA	VCCINT	N11
NA	VCCINT	M17
NA	VCCINT	M11
NA	VCCINT	L17
NA	VCCINT	L16
NA	VCCINT	L15
NA	VCCINT	L14
NA	VCCINT	L13
NA	VCCINT	L12
NA	VCCINT	L11
NA	VCCINT	K18
NA	VCCINT	K14

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
0	IO_L53N_0	G20		
0	IO_L53P_0	G19		
0	IO_L54N_0	D21		
0	IO_L54P_0	D22		
0	IO_L67N_0	E20	NC	
0	IO_L67P_0	E21	NC	
0	IO_L68N_0	H19	NC	
0	IO_L68P_0	H18	NC	
0	IO_L69N_0	D20	NC	
0	IO_L69P_0/VREF_0	D19	NC	
0	IO_L70N_0	A20	NC	
0	IO_L70P_0	A21	NC	
0	IO_L71N_0	F19	NC	
0	IO_L71P_0	F18	NC	
0	IO_L72N_0	C19	NC	
0	IO_L72P_0	C20	NC	
0	IO_L73N_0	B18	NC	NC
0	IO_L73P_0	B19	NC	NC
0	IO_L74N_0	G18	NC	NC
0	IO_L74P_0	H17	NC	NC
0	IO_L75N_0	E18	NC	NC
0	IO_L75P_0/VREF_0	D18	NC	NC
0	IO_L76N_0	A18	NC	NC
0	IO_L76P_0	A19	NC	NC
0	IO_L77N_0	J17	NC	NC
0	IO_L77P_0	J16	NC	NC
0	IO_L78N_0	E16	NC	NC
0	IO_L78P_0	E17	NC	NC
0	IO_L91N_0/VREF_0	B17		
0	IO_L91P_0	B16		
0	IO_L92N_0	F17		
0	IO_L92P_0	F16		
0	IO_L93N_0	D16		
0	IO_L93P_0	D17		
0	IO_L94N_0/VREF_0	A17		
0	IO_L94P_0	A16		
0	IO_L95N_0/GCLK7P	H16		

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
6	IO_L68N_6	Y26	NC	
6	IO_L69P_6	AA30	NC	
6	IO_L69N_6/VREF_6	Y30	NC	
6	IO_L70P_6	W24	NC	
6	IO_L70N_6	V24	NC	
6	IO_L71P_6	Y27	NC	
6	IO_L71N_6	W27	NC	
6	IO_L72P_6	W28	NC	
6	IO_L72N_6	Y28	NC	
6	IO_L73P_6	V25	NC	NC
6	IO_L73N_6	U25	NC	NC
6	IO_L74P_6	V26	NC	NC
6	IO_L74N_6	V27	NC	NC
6	IO_L75P_6	Y29	NC	NC
6	IO_L75N_6/VREF_6	W29	NC	NC
6	IO_L76P_6	U22	NC	NC
6	IO_L76N_6	T22	NC	NC
6	IO_L77P_6	U26	NC	NC
6	IO_L77N_6	T26	NC	NC
6	IO_L78P_6	V30	NC	NC
6	IO_L78N_6	W30	NC	NC
6	IO_L91P_6	U23		
6	IO_L91N_6	T23		
6	IO_L92P_6	U27		
6	IO_L92N_6	T27		
6	IO_L93P_6	V29		
6	IO_L93N_6/VREF_6	U29		
6	IO_L94P_6	T24		
6	IO_L94N_6	T25		
6	IO_L95P_6	U28		
6	IO_L95N_6	T28		
6	IO_L96P_6	T30		
6	IO_L96N_6	U30		
7	IO_L96P_7	P28		
7	IO_L96N_7	R28		
7	IO_L95P_7	R25		

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
7	IO_L95N_7	R24		
7	IO_L94P_7	R29		
7	IO_L94N_7	T29		
7	IO_L93P_7/VREF_7	R27		
7	IO_L93N_7	P27		
7	IO_L92P_7	R23		
7	IO_L92N_7	P23		
7	IO_L91P_7	N30		
7	IO_L91N_7	P30		
7	IO_L78P_7	P26	NC	NC
7	IO_L78N_7	R26	NC	NC
7	IO_L77P_7	R22	NC	NC
7	IO_L77N_7	P22	NC	NC
7	IO_L76P_7	N29	NC	NC
7	IO_L76N_7	P29	NC	NC
7	IO_L75P_7/VREF_7	N27	NC	NC
7	IO_L75N_7	N26	NC	NC
7	IO_L74P_7	P25	NC	NC
7	IO_L74N_7	N25	NC	NC
7	IO_L73P_7	L30	NC	NC
7	IO_L73N_7	M30	NC	NC
7	IO_L72P_7	L28	NC	
7	IO_L72N_7	M28	NC	
7	IO_L71P_7	N24	NC	
7	IO_L71N_7	M24	NC	
7	IO_L70P_7	L29	NC	
7	IO_L70N_7	M29	NC	
7	IO_L69P_7/VREF_7	M27	NC	
7	IO_L69N_7	L27	NC	
7	IO_L68P_7	N23	NC	
7	IO_L68N_7	M23	NC	
7	IO_L67P_7	J30	NC	
7	IO_L67N_7	K30	NC	
7	IO_L54P_7	K26		
7	IO_L54N_7	L26		
7	IO_L53P_7	M25		
7	IO_L53N_7	L25		

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
4	IO_L20N_4	AJ10	
4	IO_L20P_4	AJ9	
4	IO_L21N_4	AH9	
4	IO_L21P_4/VREF_4	AH10	
4	IO_L22N_4	AN5	
4	IO_L22P_4	AN4	
4	IO_L23N_4	AE12	
4	IO_L23P_4	AE13	
4	IO_L24N_4	AM9	
4	IO_L24P_4	AL8	
4	IO_L25N_4	AP5	
4	IO_L25P_4	AP4	
4	IO_L26N_4	AG11	
4	IO_L26P_4	AG12	
4	IO_L27N_4	AN7	
4	IO_L27P_4/VREF_4	AN6	
4	IO_L28N_4	AL10	
4	IO_L28P_4	AL9	
4	IO_L29N_4	AF12	
4	IO_L29P_4	AF13	
4	IO_L30N_4	AK10	
4	IO_L30P_4	AK11	
4	IO_L49N_4	AP7	
4	IO_L49P_4	AP6	
4	IO_L50N_4	AH13	
4	IO_L50P_4	AH12	
4	IO_L51N_4	AJ11	
4	IO_L51P_4/VREF_4	AJ12	
4	IO_L52N_4	AP9	
4	IO_L52P_4	AN8	
4	IO_L53N_4	AG13	
4	IO_L53P_4	AG14	
4	IO_L54N_4	AM11	
4	IO_L54P_4	AL11	
4	IO_L60N_4	AN10	NC
4	IO_L60P_4	AN9	NC

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
6	IO_L71P_6	AD34	
6	IO_L71N_6	AC34	
6	IO_L72P_6	AC31	
6	IO_L72N_6	AD31	
6	IO_L73P_6	Y27	
6	IO_L73N_6	W27	
6	IO_L74P_6	AB29	
6	IO_L74N_6	AA29	
6	IO_L75P_6	AB31	
6	IO_L75N_6/VREF_6	AA31	
6	IO_L76P_6	Y28	
6	IO_L76N_6	Y29	
6	IO_L77P_6	AB33	
6	IO_L77N_6	AA33	
6	IO_L78P_6	AA30	
6	IO_L78N_6	AB30	
6	IO_L79P_6	W24	NC
6	IO_L79N_6	V24	NC
6	IO_L80P_6	AB34	NC
6	IO_L80N_6	AA34	NC
6	IO_L81P_6	W33	NC
6	IO_L81N_6/VREF_6	Y34	NC
6	IO_L82P_6	W25	NC
6	IO_L82N_6	V25	NC
6	IO_L83P_6	Y32	NC
6	IO_L83N_6	AA32	NC
6	IO_L84P_6	W29	NC
6	IO_L84N_6	V29	NC
6	IO_L91P_6	W28	
6	IO_L91N_6	V28	
6	IO_L92P_6	V33	
6	IO_L92N_6	V34	
6	IO_L93P_6	Y31	
6	IO_L93N_6/VREF_6	W31	
6	IO_L94P_6	V26	
6	IO_L94N_6	V27	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
NA	GND	P20	
NA	GND	P19	
NA	GND	P18	
NA	GND	P17	
NA	GND	P16	
NA	GND	P15	
NA	GND	P14	
NA	GND	P7	
NA	GND	M30	
NA	GND	M5	
NA	GND	K32	
NA	GND	K3	
NA	GND	J19	
NA	GND	J16	
NA	GND	H34	
NA	GND	H27	
NA	GND	H8	
NA	GND	H1	
NA	GND	G28	
NA	GND	G21	
NA	GND	G14	
NA	GND	G7	
NA	GND	F29	
NA	GND	F6	
NA	GND	E30	
NA	GND	E23	
NA	GND	E12	
NA	GND	E5	
NA	GND	D31	
NA	GND	D4	
NA	GND	C34	
NA	GND	C32	
NA	GND	C25	
NA	GND	C10	
NA	GND	C3	
NA	GND	C1	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	IO_L33N_1/VREF_1	D11	NC	
1	IO_L33P_1	D12	NC	
1	IO_L32N_1	H14	NC	
1	IO_L32P_1	H13	NC	
1	IO_L31N_1	A8	NC	
1	IO_L31P_1	A9	NC	
1	IO_L30N_1	F11		
1	IO_L30P_1	F12		
1	IO_L29N_1	K14		
1	IO_L29P_1	L14		
1	IO_L28N_1	C9		
1	IO_L28P_1	C10		
1	IO_L27N_1/VREF_1	G11		
1	IO_L27P_1	G12		
1	IO_L26N_1	M15		
1	IO_L26P_1	M14		
1	IO_L25N_1	B7		
1	IO_L25P_1	B8		
1	IO_L24N_1	D9		
1	IO_L24P_1	D10		
1	IO_L23N_1	J13		
1	IO_L23P_1	J12		
1	IO_L22N_1	A6		
1	IO_L22P_1	A7		
1	IO_L21N_1/VREF_1	E9		
1	IO_L21P_1	E10		
1	IO_L20N_1	D8		
1	IO_L20P_1	E7		
1	IO_L19N_1	C7		
1	IO_L19P_1	C8		
1	IO_L12N_1	F9	NC	
1	IO_L12P_1	F10	NC	
1	IO_L11N_1	H12	NC	
1	IO_L11P_1	H11	NC	
1	IO_L10N_1	B5	NC	
1	IO_L10P_1	B6	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
4	IO_L32P_4	AM14	NC	
4	IO_L33N_4	AT10	NC	
4	IO_L33P_4/VREF_4	AT9	NC	
4	IO_L34N_4	AV10	NC	
4	IO_L34P_4	AV9	NC	
4	IO_L35N_4	AH16	NC	
4	IO_L35P_4	AH17	NC	
4	IO_L36N_4	AP13	NC	
4	IO_L36P_4	AP12	NC	
4	IO_L49N_4	AU12		
4	IO_L49P_4	AU11		
4	IO_L50N_4	AK15		
4	IO_L50P_4	AJ16		
4	IO_L51N_4	AT12		
4	IO_L51P_4/VREF_4	AT11		
4	IO_L52N_4	AN15		
4	IO_L52P_4	AN14		
4	IO_L53N_4	AR12		
4	IO_L53P_4	AR13		
4	IO_L54N_4	AT14		
4	IO_L54P_4	AT13		
4	IO_L55N_4	AW11		
4	IO_L55P_4	AW10		
4	IO_L56N_4	AM15		
4	IO_L56P_4	AM16		
4	IO_L57N_4	AP15		
4	IO_L57P_4/VREF_4	AP14		
4	IO_L58N_4	AV13		
4	IO_L58P_4	AV12		
4	IO_L59N_4	AK16		
4	IO_L59P_4	AK17		
4	IO_L60N_4	AR16		
4	IO_L60P_4	AR15		
4	IO_L67N_4	AW13		
4	IO_L67P_4	AW12		
4	IO_L68N_4	AL16		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
5	IO_L25N_5	AV33		
5	IO_L25P_5	AV32		
5	IO_L24N_5	AR31		
5	IO_L24P_5	AR30		
5	IO_L23N_5	AL27		
5	IO_L23P_5	AL28		
5	IO_L22N_5	AW34		
5	IO_L22P_5	AW33		
5	IO_L21N_5/VREF_5	AN30		
5	IO_L21P_5	AP30		
5	IO_L20N_5	AM28		
5	IO_L20P_5	AM29		
5	IO_L19N_5	AU33		
5	IO_L19P_5	AU32		
5	IO_L12N_5	AT33	NC	
5	IO_L12P_5	AT32	NC	
5	IO_L11N_5	AK27	NC	
5	IO_L11P_5	AK28	NC	
5	IO_L10N_5	AV35	NC	
5	IO_L10P_5	AV34	NC	
5	IO_L09N_5/VREF_5	AP32	NC	
5	IO_L09P_5	AP31	NC	
5	IO_L08N_5	AL29	NC	
5	IO_L08P_5	AK29	NC	
5	IO_L07N_5	AW36	NC	
5	IO_L07P_5	AW35	NC	
5	IO_L06N_5	AR33		
5	IO_L06P_5	AR32		
5	IO_L05N_5/VRP_5	AM30		
5	IO_L05P_5/VRN_5	AL30		
5	IO_L04N_5	AU35		
5	IO_L04P_5/VREF_5	AU34		
5	IO_L03N_5/D4/ALT_VRP_5	AR34		
5	IO_L03P_5/D5/ALT_VRN_5	AT34		
5	IO_L02N_5/D6	AN31		
5	IO_L02P_5/D7	AM31		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
7	IO_L50P_7	P32		
7	IO_L50N_7	N32		
7	IO_L49P_7	L37		
7	IO_L49N_7	M37		
7	IO_L48P_7	N34		
7	IO_L48N_7	P34		
7	IO_L47P_7	P31		
7	IO_L47N_7	N31		
7	IO_L46P_7	M35		
7	IO_L46N_7	N35		
7	IO_L45P_7/VREF_7	L36		
7	IO_L45N_7	M36		
7	IO_L44P_7	R28		
7	IO_L44N_7	P28		
7	IO_L43P_7	K39		
7	IO_L43N_7	L39		
7	IO_L36P_7	L34	NC	
7	IO_L36N_7	M34	NC	
7	IO_L35P_7	P29	NC	
7	IO_L35N_7	N29	NC	
7	IO_L34P_7	J38	NC	
7	IO_L34N_7	K38	NC	
7	IO_L33P_7/VREF_7	L33	NC	
7	IO_L33N_7	M33	NC	
7	IO_L32P_7	M32	NC	
7	IO_L32N_7	L32	NC	
7	IO_L31P_7	H39	NC	
7	IO_L31N_7	J39	NC	
7	IO_L30P_7	J36		
7	IO_L30N_7	K36		
7	IO_L29P_7	N30		
7	IO_L29N_7	M30		
7	IO_L28P_7	J37		
7	IO_L28N_7	K37		
7	IO_L27P_7/VREF_7	J35		
7	IO_L27N_7	K35		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
NA	GND	Y17		
NA	GND	Y16		
NA	GND	Y10		
NA	GND	Y7		
NA	GND	Y4		
NA	GND	Y1		
NA	GND	W24		
NA	GND	W23		
NA	GND	W22		
NA	GND	W21		
NA	GND	W20		
NA	GND	W19		
NA	GND	W18		
NA	GND	W17		
NA	GND	W16		
NA	GND	V24		
NA	GND	V23		
NA	GND	V22		
NA	GND	V21		
NA	GND	V20		
NA	GND	V19		
NA	GND	V18		
NA	GND	V17		
NA	GND	V16		
NA	GND	U36		
NA	GND	U32		
NA	GND	U24		
NA	GND	U23		
NA	GND	U22		
NA	GND	U21		
NA	GND	U20		
NA	GND	U19		
NA	GND	U18		
NA	GND	U17		
NA	GND	U16		
NA	GND	U8		